FDP6670AL/FDB6670AL

FDP6670AL/FDB6670AL N-Channel Logic Level PowerTrench^o MOSFET

General Description

G

D

 $R_{\theta JA}$

S

This N-Channel Logic Level MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable $R_{\text{DS(ON)}}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

It has been optimized for low gate charge, low $R_{\text{DS}(\text{ON})}$ and fast switching speed.

Features

- 80 A, 30 V $R_{DS(ON)} = 6.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 8.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Critical DC electrical parameters specified at elevated temperature
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- 175°C maximum junction temperature rating

62.5



TO-220

FDP Series

| Symbol | Parameter | Ratings | Units |
|---------------------|--|-------------|-------|
| V _{DSS} | Drain-Source Voltage | 30 | V |
| V _{GSS} | Gate-Source Voltage | ± 20 | V |
| ID | Drain Current – Continuous (Note 1) | 80 | Α |
| | - Pulsed (Note 1) | 240 | |
| PD | Total Power Dissipation @ $T_c = 25^{\circ}C$ | 68 | W |
| | Derate above 25°C | 0.45 | W/∘C |
| T_{J}, T_{STG} | Operating and Storage Junction Temperature Range | -65 to +175 | °C |
| Therma | I Characteristics | | |
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction-to-Case | 2.2 | °C/W |

D

TO-263AB

FDB Series

Package Marking and Ordering Information

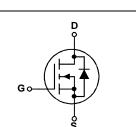
Thermal Resistance, Junction-to-Ambient

| Device | Reel Size | Tape width | Quantity |
|----------|-----------|---------------|-------------------|
| DB6670AL | 13" | 24mm | 800 units |
| DP6670AL | Tube | n/a | 45 |
| | DB6670AL | FDB6670AL 13" | DB6670AL 13" 24mm |

©2003 Fairchild Semiconductor Corporation

FDP6670AL/FDB6670AL Rev D(W)

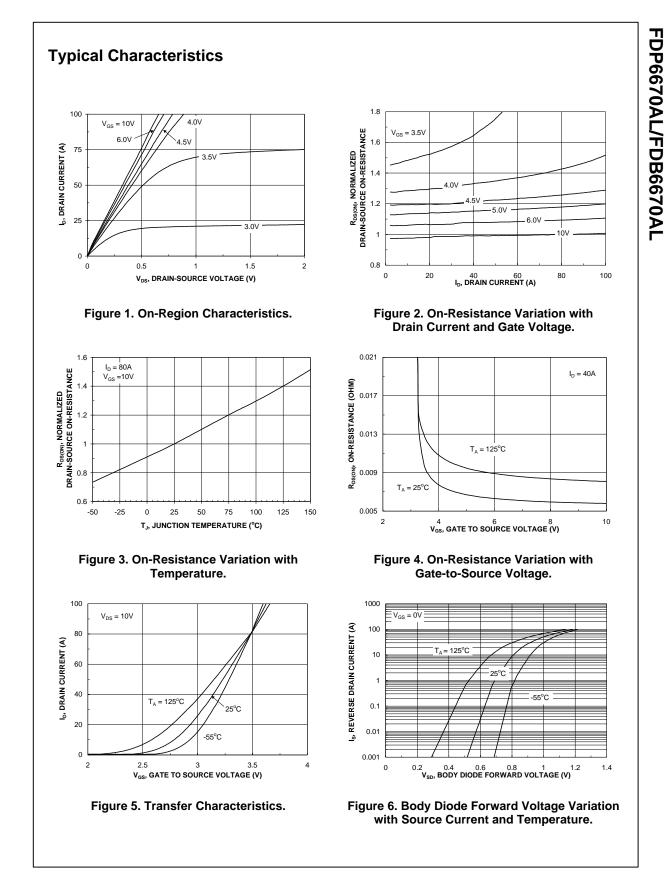
°C/W



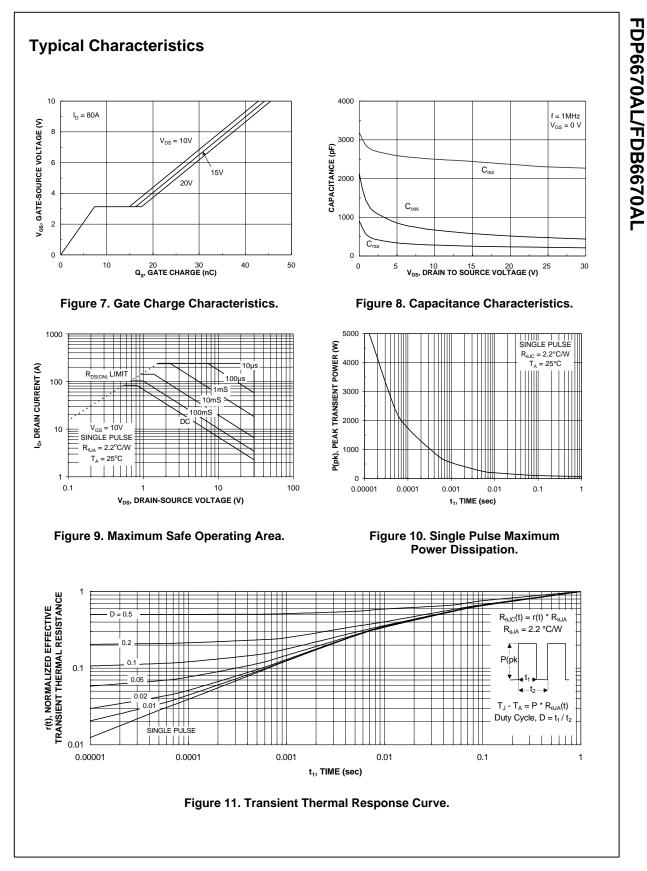
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|------------------------------|---|--|-----|------------|------------|-------|
| - | | | | 196 | тах | Unito |
| | ource Avalanche Ratings (Note | | | | | |
| W _{DSS} | Single Pulse Drain-Source Avalanche Energy | $V_{DD} = 15 \text{ V}, \qquad I_D = 80 \text{ A}$ | | | 114 | mJ |
| I _{AR} | Maximum Drain-Source Avalanche Current | | | | 80 | A |
| Off Char | acteristics | | | | | |
| BV _{DSS} | Drain–Source Breakdown Voltage | $V_{GS}=0~V, \qquad I_D=250~\mu A$ | 30 | | | V |
| $\Delta BV_{DSS} \Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ | | 24 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$ | | | 1 | μA |
| I _{GSS} | Gate–Body Leakage | $V_{GS}=\pm~20~V, V_{DS}=0~V$ | | | ±100 | nA |
| On Char | acteristics (Note 2) | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1 | 1.9 | 3 | V |
| <u>ΔVgs(th)</u> ΔTJ | Gate Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu\text{A}$, Referenced to 25°C | | -5 | | mV/°C |
| R _{DS(on)} | Static Drain–Source On– Resistance | | | 5.2 6.5 | 6.5 8.5 | mΩ |
| | | V_{GS} = 10 V, I_D = 40 A, T_J =125°C | | 7.2 | 9.7 | |
| D(on) | On–State Drain Current | $V_{GS} = 10 \text{ V}, V_{DS} = 10 \text{ V}$ | 80 | | | A |
| g fs | Forward Transconductance | $V_{DS} = 10V, \qquad I_D = 40 \text{ A}$ | | 115 | | S |
| Dynamic | Characteristics | | | | | |
| Ciss | Input Capacitance | $V_{DS} = 15 V$, $V_{GS} = 0 V$, | | 2440 | | pF |
| Coss | Output Capacitance | f = 1.0 MHz | | 580 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 250 | | pF |
| R _G | Gate Resistance | $V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$ | | 1.4 | | Ω |
| Switchin | g Characteristics (Note 2) | | | | | |
| t _{d(on)} | Turn–On Delay Time | $V_{DD} = 10V, \qquad I_D = 1 \text{ A},$ | | 13 | 23 | ns |
| t _r | Turn–On Rise Time | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ | | 13 | 23 | ns |
| t _{d(off)} | Turn–Off Delay Time | - | | 42 | 68 | ns |
| t _f | Turn–Off Fall Time | | | 15 | 27 | ns |
| Qg | Total Gate Charge | $V_{DS} = 15 V$, $I_D = 40 A$, | | 24 | 33 | nC |
| Q _{gs} | Gate–Source Charge | $V_{GS} = 5 V$ | | 7 | | nC |
| Q _{gd} | Gate-Drain Charge | 7 | | 9 | | nC |
| - | ource Diode Characteristics | and Maximum Ratings | • | | | |
| l _s | Maximum Continuous Drain–Source | | | | 80 | А |
| V _{SD} | Drain–Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_S = 40 \text{ A} (\text{Note 1})$ | | 0.9 | 1.3 | V |
| t _{rr} | Diode Reverse Recovery Time | $I_{\rm F} = 40$ A, | + | 34 | | nS |
| Q _{rr} | Diode Reverse Recovery Charge | $d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$ | | 24 | | nC |

1. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDP6670AL/FDB6670AL



FDP6670AL/FDB6670AL Rev D(W)



FDP6670AL/FDB6670AL Rev D(W)

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| ACEx™ | FACT™ | ImpliedDisconnect [™] | PACMAN™ | SPM™ |
|----------------------|-----------------------|--------------------------------|------------------------------|-----------------------|
| ActiveArray™ | FACT Quiet Series™ | ISOPLANAR™ | POP™ | Stealth™ |
| Bottomless™ | FAST® | LittleFET™ | Power247™ | SuperSOT™-3 |
| CoolFET™ | FASTr™ | MicroFET™ | PowerTrench [®] | SuperSOT™-6 |
| CROSSVOLT™ | FRFET™ | MicroPak™ | QFET [®] | SuperSOT™-8 |
| DOME™ | GlobalOptoisolator™ | MICROWIRE™ | QS™ | SyncFET™ |
| EcoSPARK™ | GTO™ | MSX™ | QT Optoelectronics™ | TinyLogic® |
| E²CMOS™ | HiSeC™ | MSXPro™ | Quiet Series™ | TruTranslation™ |
| EnSigna™ | I²C™ | OCX™ | RapidConfigure™ | UHC™ |
| Across the board | I. Around the world.™ | OCXPro™ | RapidConnect™ | UltraFET [®] |
| The Power Franchise™ | | OPTOLOGIC [®] | SILENT SWITCHER [®] | VCX™ |
| Programmable A | ctive Droop™ | OPTOPLANAR™ | SMART START™ | |

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Product Status | Definition |
|---------------------------|---|
| Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |
| | Formative or In Design First Production Full Production |